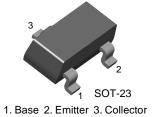


BCW60A/B/C/D

General Purpose Transistor



NPN Epitaxial Silicon Transistor

Absolute Maximum Ratings T_a=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V _{CBO}	Collector-Base Voltage	32	V	
V _{CEO}	Collector-Emitter Voltage	32	V	
V _{EBO} Emitter-Base Voltage		5	V	
I _C	Collector Current	100	mA	
Collector Power Dissipation		350	mW	
T _{STG} Storage Temperature		150	°C	

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Electrical Characteristics T_a =25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C=2mA$, $I_B=0$	32		V
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E =1μA, I _C =0	5		V
I _{CES}	Collector Cut-off Current	V _{CE} =32V, V _{BE} =0		20	nA
I _{EBO}	Emitter Cut-off Current	V _{EB} =4V, I _C =0		20	nA
h _{FE}	DC Current Gain : BCW60B : BCW60C : BCW60D : BCW60A : BCW60B : BCW60C : BCW60D : BCW60D : BCW60D : BCW60A : BCW60A	V_{CE} =5V, I_{C} =10 μ A V_{CE} =5V, I_{C} =2mA V_{CE} =1V, I_{C} =50mA	20 40 100 120 180 250 380 60 70 90 100	220 310 460 630	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C =50mA, I _B =1.25mA I _C =10mA, I _B =0.25mA		0.55 0.35	V V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C =50mA, I _B =1.25mA I _C =10mA, I _B =0.25mA	0.7 0.6	1.05 0.85	V V
V _{BE} (on)	Base-Emitter On Voltage	V _{CE} =5V, I _C =2mA	0.55	0.75	V
C _{ob}	Output Capacitance	V _{CB} =10V, I _E =0, f=1MHz		4.5	pF
f _T	Current Gain Bandwidth Product	I _C =10mA, V _{CE} =5V, f=100MHz	125		MHz
NF	Noise Figure	I_C =0.2mA, V_{CE} =5V R_G =2K Ω , f=1KHz		6	dB
t _{ON}	Turn On Time	I _C =10mA, I _{B1} =1mA		150	ns
t _{OFF}	Turn Off Time	V_{BB} =3.6V, I_{B2} =1mA R1=R2=5K Ω ,R $_{L}$ =990 Ω		800	ns

Marking Code

Туре	BCW60A	BCW60B	BCW60C	BCW60D
Mark.	AA	AB	AC	AD

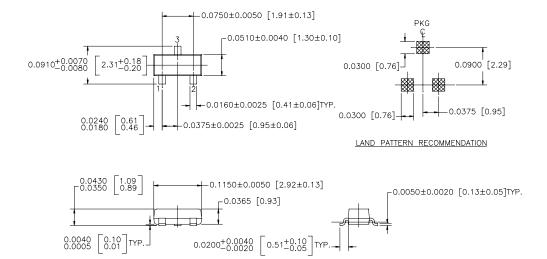




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Package Dimensions

SOT-23



NOTE: UNLESS OTHERWISE SPECIFIED

- 1. STANDARD LEAD FINISH 150 MICROINCHES / 3.81 MICROMETERS MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
- 2. REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

Dimensions in Millimeters

SOT 23, 3 LEADS LOW PROFILE

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